

ASRock®

B560M-HDV

User Manual

Version 1.0

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Contents

Chapter 1 Introduction	1
1.1 Package Contents	1
1.2 Specifications	2
1.3 Motherboard Layout	6
1.4 I/O Panel	8
Chapter 2 Installation	10
2.1 Installing the CPU	11
2.2 Installing the CPU Fan and Heatsink	14
2.3 Installing Memory Modules (DIMM)	15
2.4 Expansion Slots (PCI Express Slots)	17
2.5 Jumpers Setup	18
2.6 Onboard Headers and Connectors	19
2.7 M.2_SSD (NGFF) Module Installation Guide	24
Chapter 3 Software and Utilities Operation	29
3.1 Installing Drivers	29
3.2 ASRock Motherboard Utility (A-Tuning)	30
3.2.1 Installing ASRock Motherboard Utility (A-Tuning)	30
3.2.2 Using ASRock Motherboard Utility (A-Tuning)	30
3.3 ASRock Live Update & APP Shop	33
3.3.1 UI Overview	33
3.3.2 Apps	34
3.3.3 BIOS & Drivers	37

3.3.4	Setting	38
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Chapter 4	UEFI SETUP UTILITY	39
------------------	---------------------------	-----------

4.1	Introduction	39
4.2	EZ Mode	40
4.3	Advanced Mode	41
4.3.1	UEFI Menu Bar	41
4.3.2	Navigation Keys	42
4.4	Main Screen	43
4.5	OC Tweaker Screen	44
4.6	Advanced Screen	55
4.6.1	CPU Configuration	56
4.6.2	Chipset Configuration	58
4.6.3	Storage Configuration	61
4.6.4	Super IO Configuration	62
4.6.5	ACPI Configuration	63
4.6.6	USB Configuration	64
4.6.7	Trusted Computing	65
4.7	Tools	66
4.8	Hardware Health Event Monitoring Screen	68
4.9	Security Screen	71
4.10	Boot Screen	72
4.11	Exit Screen	75

Chapter 1 Introduction

Thank you for purchasing ASRock B560M-HDV motherboard, a reliable motherboard produced under ASRock's consistently stringent quality control. It delivers excellent performance with robust design conforming to ASRock's commitment to quality and endurance.

In this documentation, Chapter 1 and 2 contains the introduction of the motherboard and step-by-step installation guides. Chapter 3 contains the operation guide of the software and utilities. Chapter 4 contains the configuration guide of the BIOS setup.



Because the motherboard specifications and the BIOS software might be updated, the content of this documentation will be subject to change without notice. In case any modifications of this documentation occur, the updated version will be available on ASRock's website without further notice. If you require technical support related to this motherboard, please visit our website for specific information about the model you are using. You may find the latest VGA cards and CPU support list on ASRock's website as well. ASRock website <http://www.asrock.com>.

1.1 Package Contents

- ASRock B560M-HDV Motherboard (Micro ATX Form Factor)
- ASRock B560M-HDV Quick Installation Guide
- ASRock B560M-HDV Support CD
- 2 x Serial ATA (SATA) Data Cables (Optional)
- 2 x Screws for M.2 Sockets (Optional)
- 1 x I/O Panel Shield

1.2 Specifications

- Platform**
- Micro ATX Form Factor
 - Solid Capacitor design

- CPU**
- Supports 10th Gen Intel® Core™ Processors and 11th Gen Intel® Core™ Processors (LGA1200)
 - Digi Power design
 - 6 Power Phase design
 - Supports Intel® Turbo Boost Max 3.0 Technology

- Chipset**
- Intel® B560

- Memory**
- Dual Channel DDR4 Memory Technology
 - 2 x DDR4 DIMM Slots
 - 11th Gen Intel® Core™ Processors support DDR4 non-ECC, un-buffered memory up to 5000+(OC)*
 - 10th Gen Intel® Core™ Processors support DDR4 non-ECC, un-buffered memory up to 4600+(OC)*
 - * 11th Gen Intel® Core™ (i9/i7/i5) support DDR4 up to 2933; Core™ (i3), Pentium® and Celeron® support DDR4 up to 2666.
 - * 10th Gen Intel® Core™ (i9/i7) support DDR4 up to 2933; Core™ (i5/i3), Pentium® and Celeron® support DDR4 up to 2666.
 - * Please refer to Memory Support List on ASRock's website for more information. (<http://www.asrock.com/>)
 - Supports ECC UDIMM memory modules (operate in non-ECC mode)
 - Max. capacity of system memory: 64GB
 - Supports Intel® Extreme Memory Profile (XMP) 2.0

- Expansion Slot**
- 11th Gen Intel® Core™ Processors**
- 1 x PCI Express 4.0 x16 Slot*
- 10th Gen Intel® Core™ Processors**
- 1 x PCI Express 3.0 x16 Slot*
- * Supports NVMe SSD as boot disks
- 2 x PCI Express 3.0 x1 Slots

Graphics

- Intel® UHD Graphics Built-in Visuals and the VGA outputs can be supported only with processors which are GPU integrated.
- 11th Gen Intel® Core™ Processors support Intel® Xe Graphics Architecture (Gen 12). 10th Gen Intel® Core™ Processors support Gen 9 Graphics
- Graphics, Media & Compute: Microsoft DirectX 12, OpenGL 4.5, Intel® Built In Visuals, Intel® Quick Sync Video, Hybrid / Switchable Graphics, OpenCL 2.1
- Display & Content Security: Rec. 2020 (Wide Color Gamut), Microsoft PlayReady 3.0, UHD/HDR Blu-ray Disc
- Three graphics output options: D-Sub, DVI-D and HDMI
- Supports Triple Monitor
- Supports HDMI 2.0 with max. resolution up to 4K x 2K (4096x2160) @ 60Hz
- Supports DVI-D with max. resolution up to 1920x1200 @ 60Hz
- Supports D-Sub with max. resolution up to 1920x1200 @ 60Hz
- Supports Auto Lip Sync, Deep Color (12bpc), xvYCC and HBR (High Bit Rate Audio) with HDMI 2.0 Port (Compliant HDMI monitor is required)
- Supports HDCP 2.3 with DVI-D and HDMI 2.0 Ports
- Supports 4K Ultra HD (UHD) playback with HDMI 2.0 Port
- * 11th Gen Intel® Core™ Processors support HDMI 2.0. 10th Gen Intel® Core™ Processors support HDMI 1.4.

Audio

- 7.1 CH HD Audio (Realtek ALC897 Audio Codec)
- Supports Surge Protection

LAN

- Gigabit LAN 10/100/1000 Mb/s
- Giga PHY Intel® I219V
- Supports Wake-On-LAN
- Supports Lightning/ESD Protection
- Supports Energy Efficient Ethernet 802.3az
- Supports PXE

Rear Panel I/O

- 1 x PS/2 Mouse/Keyboard Port
- 1 x D-Sub Port
- 1 x DVI-D Port
- 1 x HDMI Port
- 2 x USB 2.0 Ports (Supports ESD Protection)
- 4 x USB 3.2 Gen1 Ports (Supports ESD Protection)
- 1 x RJ-45 LAN Port with LED (ACT/LINK LED and SPEED LED)
- HD Audio Jacks: Line in / Front Speaker / Microphone

Storage

- 4 x SATA3 6.0 Gb/s Connectors, support Intel Rapid Storage Technology 18, NCQ, AHCI and Hot Plug
- 1 x Hyper M.2 Socket (M2_1), supports M Key type 2260/2280 M.2 PCI Express module up to Gen4x4 (64 Gb/s) (Only supported with 11th Gen Intel® Core™ Processors)*
- 1 x Ultra M.2 Socket (M2_2), supports M Key type 2260/2280 M.2 SATA3 6.0 Gb/s module and M.2 PCI Express module up to Gen3 x4 (32 Gb/s)*

* Supports Intel® Optane™ Technology (M2_2)

* Supports NVMe SSD as boot disks

* Supports ASRock U.2 Kit

Connector

- 1 x COM Port Header
- 1 x SPI TPM Header
- 1 x Chassis Intrusion and Speaker Header
- 1 x CPU Fan Connector (4-pin)
- * The CPU Fan Connector supports the CPU fan of maximum 1A (12W) fan power.
- 1 x CPU/Water Pump Fan Connector (4-pin) (Smart Fan Speed Control)
- * The CPU/Water Pump Fan supports the water cooler fan of maximum 2A (24W) fan power.
- 2 x Chassis/Water Pump Fan Connectors (4-pin) (Smart Fan Speed Control)
- * The Chassis/Water Pump Fan supports the water cooler fan of maximum 2A (24W) fan power.
- * CPU_FAN2/WP, CHA_FAN1/WP and CHA_FAN2/WP can auto detect if 3-pin or 4-pin fan is in use.

- 1 x 24 pin ATX Power Connector
- 1 x 8 pin 12V Power Connector
- 1 x Front Panel Audio Connector
- 2 x USB 2.0 Headers (Support 4 USB 2.0 ports) (Supports ESD Protection)
- 1 x USB 3.2 Gen1 Header (Supports 2 USB 3.2 Gen1 ports) (Supports ESD Protection)

BIOS Feature

- AMI UEFI Legal BIOS with multilingual GUI support
- ACPI 6.0 Compliant wake up events
- SMBIOS 2.7 Support
- CPU Core/Cache, GT, DRAM, VPPM, VCCIN_AUX, VCCST, VCCSA Voltage Multi-adjustment

Hardware Monitor

- Fan Tachometer: CPU, CPU/Water Pump, Chassis/Water Pump Fans
- Quiet Fan (Auto adjust chassis fan speed by CPU temperature): CPU, CPU/Water Pump, Chassis/Water Pump Fans
- Fan Multi-Speed Control: CPU, CPU/Water Pump, Chassis/Water Pump Fans
- CASE OPEN detection
- Voltage monitoring: +12V, +5V, +3.3V, CPU Vcore, DRAM, VPPM, VCCIN_AUX, VCCSA, VCCST, ATX_5VSB

OS

- Microsoft® Windows® 10 64-bit

Certifica- tions

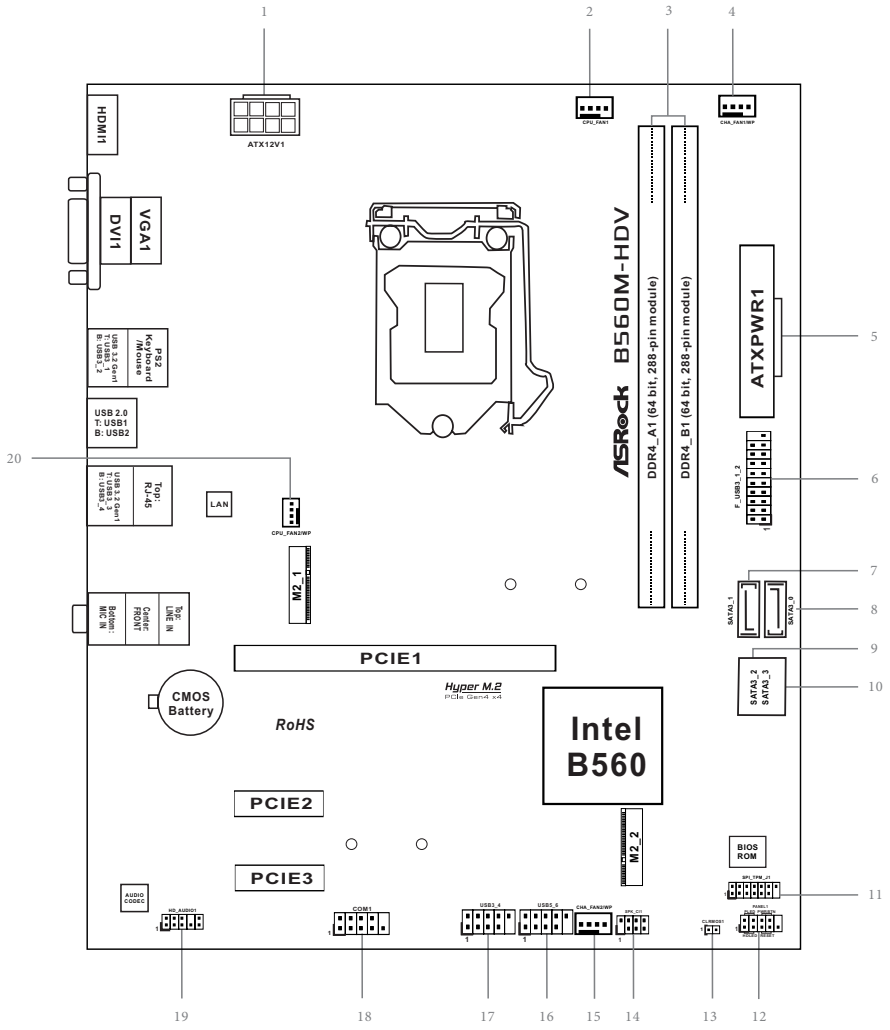
- FCC, CE
- ErP/EuP Ready (ErP/EuP ready power supply is required)

* For detailed product information, please visit our website: <http://www.asrock.com>



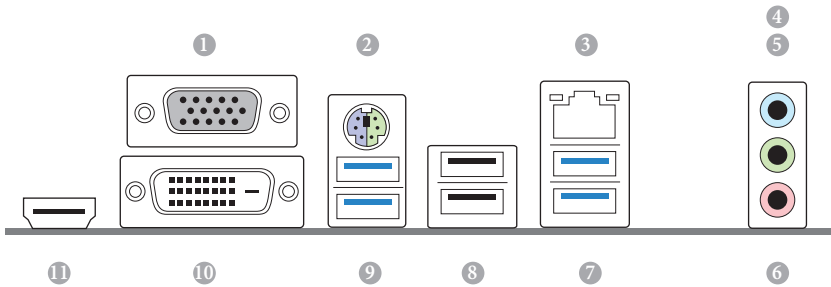
Please realize that there is a certain risk involved with overclocking, including adjusting the setting in the BIOS, applying Untied Overclocking Technology, or using third-party overclocking tools. Overclocking may affect your system's stability, or even cause damage to the components and devices of your system. It should be done at your own risk and expense. We are not responsible for possible damage caused by overclocking.

1.3 Motherboard Layout



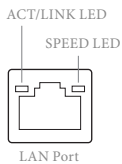
No.	Description
1	ATX 12V Power Connector (ATX12V1)
2	CPU Fan Connector (CPU_FAN1)
3	2 x 288-pin DDR4 DIMM Slots (DDR4_A1, DDR4_B1)
4	Chassis/Water Pump Fan Connector (CHA_FAN1/WP)
5	ATX Power Connector (ATXPWR1)
6	USB 3.2 Gen1 Header (F_USB3_1_2)
7	SATA3 Connector (SATA3_1)
8	SATA3 Connector (SATA3_0)
9	SATA3 Connector (SATA3_2)(Upper)
10	SATA3 Connector (SATA3_3)(Lower)
11	SPI TPM Header (SPI_TPM_J1)
12	System Panel Header (PANEL1)
13	Clear CMOS Jumper (CLRMOS1)
14	Chassis Intrusion and Speaker Header (SPK_C11)
15	Chassis/Water Pump Fan Connector (CHA_FAN2/WP)
16	USB 2.0 Header (USB5_6)
17	USB 2.0 Header (USB3_4)
18	COM Port Header (COM1)
19	Front Panel Audio Header (HD_AUDIO1)
20	CPU/Water Pump Fan Connector (CPU_FAN2/WP)

1.4 I/O Panel



No.	Description	No.	Description
1	D-Sub Port	7	USB 3.2 Gen1 Ports (USB3_3_4)
2	PS/2 Mouse/Keyboard Port	8	USB 2.0 Ports (USB1_2)
3	LAN RJ-45 Port*	9	USB 3.2 Gen1 Ports (USB3_1_2)
4	Line In (Light Blue)**	10	DVI-D Port
5	Front Speaker (Lime)**	11	HDMI Port
6	Microphone (Pink)**		

* There are two LEDs on each LAN port. Please refer to the table below for the LAN port LED indications.



Activity / Link LED		Speed LED	
Status	Description	Status	Description
Off	No Link	Off	10Mbps connection
Blinking	Data Activity	Orange	100Mbps connection
On	Link	Green	1Gbps connection

**** Function of the Audio Ports in 7.1-channel Configuration:**

Port	Function
Light Blue (Rear panel)	Rear Speaker Out
Lime (Rear panel)	Front Speaker Out
Pink (Rear panel)	Central /Subwoofer Speaker Out
Lime (Front panel)	Side Speaker Out

Chapter 2 Installation

This is a Micro ATX form factor motherboard. Before you install the motherboard, study the configuration of your chassis to ensure that the motherboard fits into it.

Pre-installation Precautions

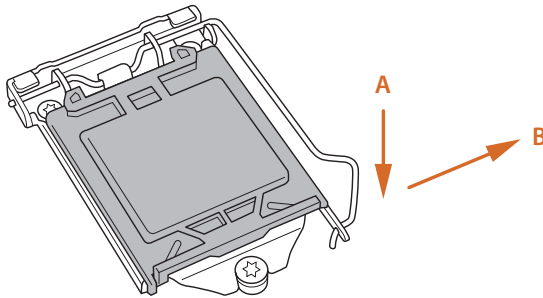
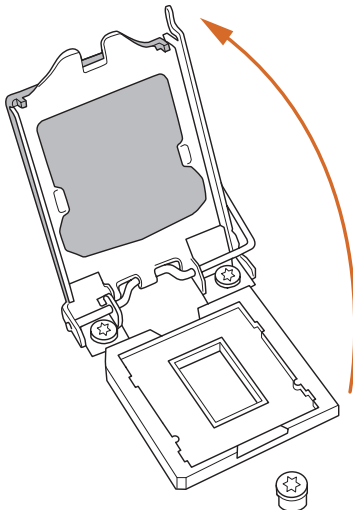
Take note of the following precautions before you install motherboard components or change any motherboard settings.

- Make sure to unplug the power cord before installing or removing the motherboard components. Failure to do so may cause physical injuries and damages to motherboard components.
- In order to avoid damage from static electricity to the motherboard's components, NEVER place your motherboard directly on a carpet. Also remember to use a grounded wrist strap or touch a safety grounded object before you handle the components.
- Hold components by the edges and do not touch the ICs.
- Whenever you uninstall any components, place them on a grounded anti-static pad or in the bag that comes with the components.
- When placing screws to secure the motherboard to the chassis, please do not over-tighten the screws! Doing so may damage the motherboard.

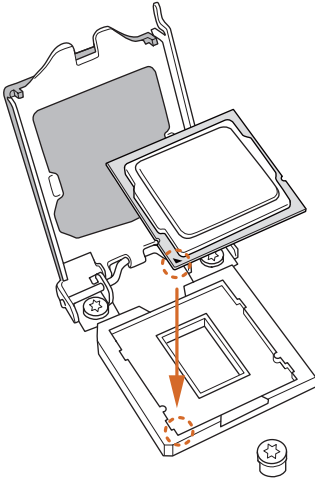
2.1 Installing the CPU



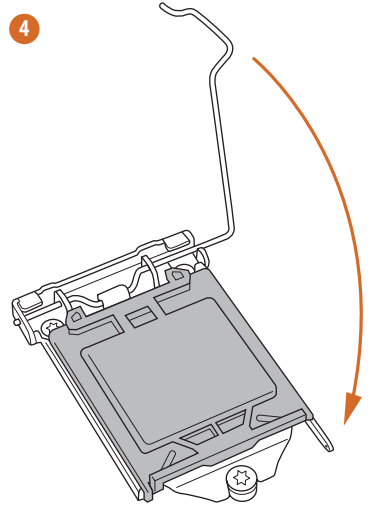
1. Before you insert the 1200-Pin CPU into the socket, please check if the **PnP cap** is on the socket, if the CPU surface is unclean, or if there are any **bent pins** in the socket. Do not force to insert the CPU into the socket if above situation is found. Otherwise, the CPU will be seriously damaged.
2. Unplug all power cables before installing the CPU.

1**2**

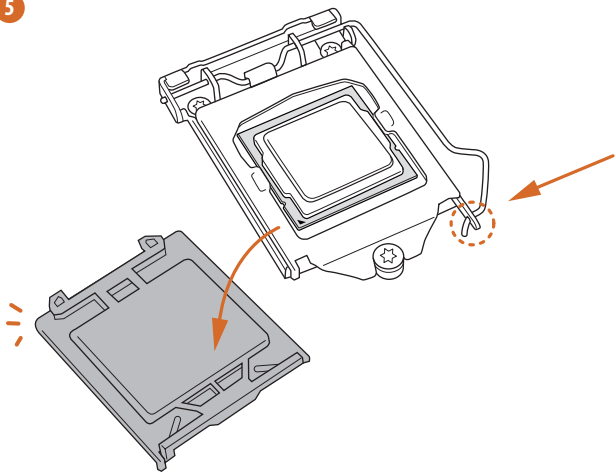
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4



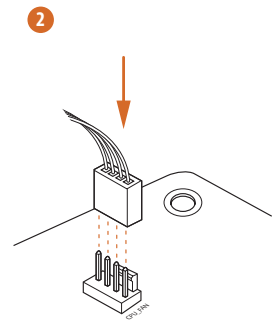
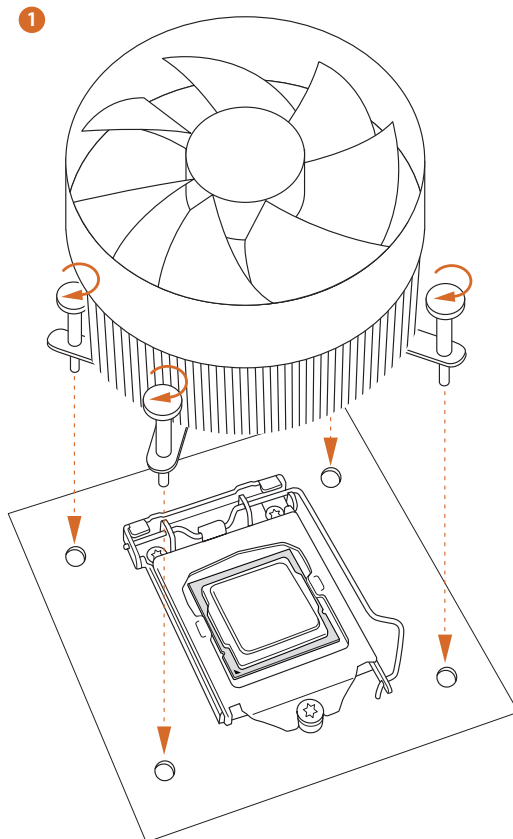
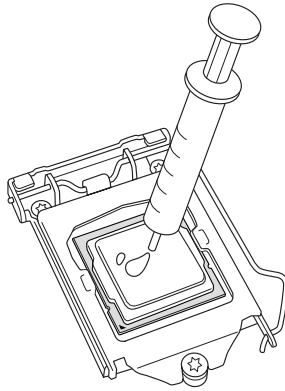
5





Please save and replace the cover if the processor is removed. The cover must be placed if you wish to return the motherboard for after service.

2.2 Installing the CPU Fan and Heatsink



2.3 Installing Memory Modules (DIMM)

This motherboard provides two 288-pin DDR4 (Double Data Rate 4) DIMM slots, and supports Dual Channel Memory Technology.

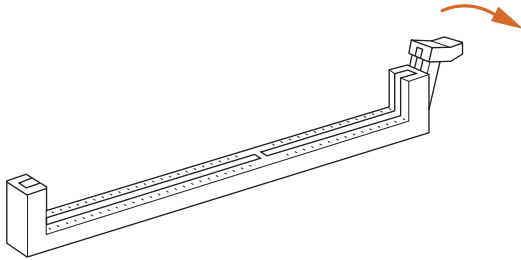


1. For dual channel configuration, you always need to install identical (the same brand, speed, size and chip-type) DDR4 DIMM pairs.
2. It is unable to activate Dual Channel Memory Technology with only one memory module installed.
3. It is not allowed to install a DDR, DDR2 or DDR3 memory module into a DDR4 slot; otherwise, this motherboard and DIMM may be damaged.

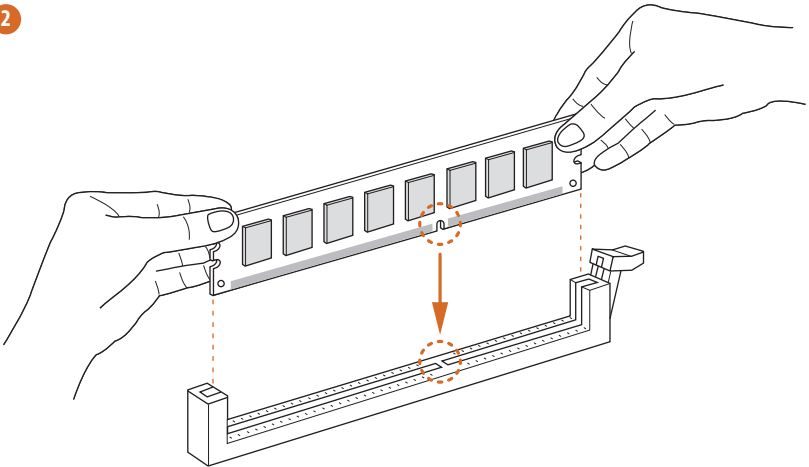


The DIMM only fits in one correct orientation. It will cause permanent damage to the motherboard and the DIMM if you force the DIMM into the slot at incorrect orientation.

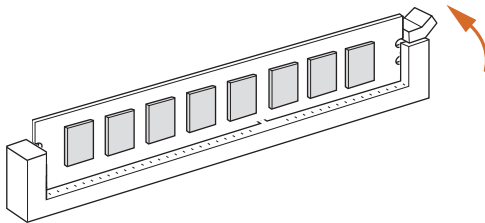
1



2



3



2.4 Expansion Slots (PCI Express Slots)

There are 3 PCI Express slots on the motherboard.



Before installing an expansion card, please make sure that the power supply is switched off or the power cord is unplugged. Please read the documentation of the expansion card and make necessary hardware settings for the card before you start the installation.

PCIe slots:

11th Gen Intel® Core™ Processors:

PCIE1 (PCIe 4.0 x16 slot) is used for PCI Express x16 lane width graphics cards.

PCIE2 (PCIe 3.0 x1 slot) is used for PCI Express x1 lane width cards.

PCIE3 (PCIe 3.0 x1 slot) is used for PCI Express x1 lane width cards.

10th Gen Intel® Core™ Processors:

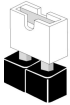
PCIE1 (PCIe 3.0 x16 slot) is used for PCI Express x16 lane width graphics cards.

PCIE2 (PCIe 3.0 x1 slot) is used for PCI Express x1 lane width cards.

PCIE3 (PCIe 3.0 x1 slot) is used for PCI Express x1 lane width cards.

2.5 Jumpers Setup

The illustration shows how jumpers are setup. When the jumper cap is placed on the pins, the jumper is “Short”. If no jumper cap is placed on the pins, the jumper is “Open”.



Short



Open

Clear CMOS Jumper
(CLRMOS1)
(see p.6, No. 13)



2-pin Jumper

CLRMOS1 allows you to clear the data in CMOS. To clear and reset the system parameters to default setup, please turn off the computer and unplug the power cord from the power supply. After waiting for 15 seconds, use a jumper cap to short the pins on CLRMOS1 for 5 seconds. However, please do not clear the CMOS right after you update the BIOS. If you need to clear the CMOS when you just finish updating the BIOS, you must boot up the system first, and then shut it down before you do the clear-CMOS action. Please be noted that the password, date, time, and user default profile will be cleared only if the CMOS battery is removed. Please remember to remove the jumper cap after clearing the CMOS.



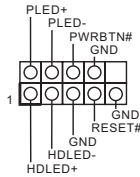
If you clear the CMOS, the case open may be detected. Please adjust the BIOS option “Clear Status” to clear the record of previous chassis intrusion status.

2.6 Onboard Headers and Connectors



Onboard headers and connectors are NOT jumpers. Do NOT place jumper caps over these headers and connectors. Placing jumper caps over the headers and connectors will cause permanent damage to the motherboard.

System Panel Header
(9-pin PANEL1)
(see p.6, No. 12)



Connect the power switch, reset switch and system status indicator on the chassis to this header according to the pin assignments below. Note the positive and negative pins before connecting the cables.



PWRBTN (Power Switch):

Connect to the power switch on the chassis front panel. You may configure the way to turn off your system using the power switch.

RESET (Reset Switch):

Connect to the reset switch on the chassis front panel. Press the reset switch to restart the computer if the computer freezes and fails to perform a normal restart.

PLED (System Power LED):

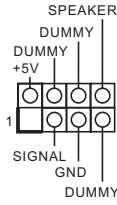
Connect to the power status indicator on the chassis front panel. The LED is on when the system is operating. The LED keeps blinking when the system is in S1/S3 sleep state. The LED is off when the system is in S4 sleep state or powered off (S5).

HDLED (Hard Drive Activity LED):

Connect to the hard drive activity LED on the chassis front panel. The LED is on when the hard drive is reading or writing data.

The front panel design may differ by chassis. A front panel module mainly consists of power switch, reset switch, power LED, hard drive activity LED, speaker and etc. When connecting your chassis front panel module to this header, make sure the wire assignments and the pin assignments are matched correctly.

Chassis Intrusion and
Speaker Header
(7-pin SPK_CI1)
(see p.6, No. 14)



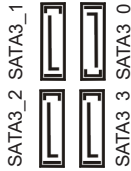
Please connect the
chassis intrusion and the
chassis speaker to this
header.

Serial ATA3 Connectors
Vertical:

(SATA3_0:
see p.6, No. 8)
(SATA3_1:
see p.6, No. 7)

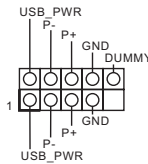
Right Angle:

(SATA3_2:
see p.6, No. 9)(Upper)
(SATA3_3:
see p.6, No. 10)(Lower)



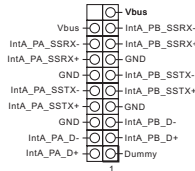
These four SATA3
connectors support SATA
data cables for internal
storage devices with up to
6.0 Gb/s data transfer rate.

USB 2.0 Headers
(9-pin USB3_4)
(see p.6, No. 17)
(9-pin USB5_6)
(see p.6, No. 16)



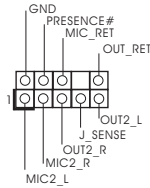
There are two USB
2.0 headers on this
motherboard. Each USB
2.0 header can support
two ports.

USB 3.2 Gen1 Header
(19-pin F_USB3_1_2)
(see p.6, No. 6)



There is one header on
this motherboard. This
USB 3.2 Gen1 header can
support two ports.

Front Panel Audio Header
(9-pin HD_AUDIO1)
(see p.6, No. 19)

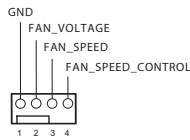


This header is for connecting audio devices to the front audio panel.



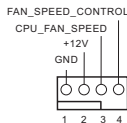
- High Definition Audio supports Jack Sensing, but the panel wire on the chassis must support HDA to function correctly. Please follow the instructions in our manual and chassis manual to install your system.
- If you use an AC'97 audio panel, please install it to the front panel audio header by the steps below:
 - Connect Mic_IN (MIC) to MIC2_L.
 - Connect Audio_R (RIN) to OUT2_R and Audio_L (LIN) to OUT2_L.
 - Connect Ground (GND) to Ground (GND).
 - MIC_RET and OUT_RET are for the HD audio panel only. You don't need to connect them for the AC'97 audio panel.
 - To activate the front mic, go to the "FrontMic" Tab in the Realtek Control panel and adjust "Recording Volume".

Chassis/Water Pump Fan Connectors
(4-pin CHA_FAN1/WP)
(see p.6, No. 4)
(4-pin CHA_FAN2/WP)
(see p.6, No. 15)



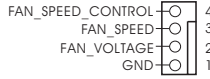
This motherboard provides two 4-Pin water cooling chassis fan connectors. If you plan to connect a 3-Pin chassis water cooler fan, please connect it to Pin 1-3.

CPU Fan Connector
(4-pin CPU_FAN1)
(see p.6, No. 2)



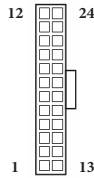
This motherboard provides a 4-Pin CPU fan (Quiet Fan) connector. If you plan to connect a 3-Pin CPU fan, please connect it to Pin 1-3.

CPU/Water Pump Fan Connector
(4-pin CPU_FAN2/WP)
(see p.6, No. 20)



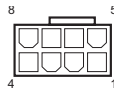
This motherboard provides a 4-Pin water cooling CPU fan connector. If you plan to connect a 3-Pin CPU water cooler fan, please connect it to Pin 1-3.

ATX Power Connector
(24-pin ATXPWR1)
(see p.6, No. 5)



This motherboard provides a 24-pin ATX power connector. To use a 20-pin ATX power supply, please plug it along Pin 1 and Pin 13.

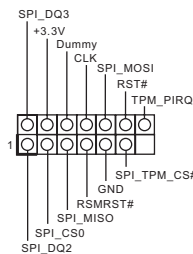
ATX 12V Power Connector
(8-pin ATX12V1)
(see p.6, No. 1)



This motherboard provides a 8-pin ATX 12V power connector. To use a 4-pin ATX power supply, please plug it along Pin 1 and Pin 5.

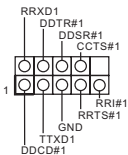
***Warning: Please make sure that the power cable connected is for the CPU and not the graphics card. Do not plug the PCIe power cable to this connector.**

SPI TPM Header
(13-pin SPI_TPM_J1)
(see p.6, No. 11)



This connector supports SPI Trusted Platform Module (TPM) system, which can securely store keys, digital certificates, passwords, and data. A TPM system also helps enhance network security, protects digital identities, and ensures platform integrity.

Serial Port Header
(9-pin COM1)
(see p.6, No. 18)

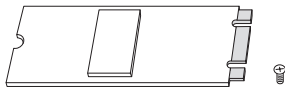


This COM1 header
supports a serial port
module.

2.7 M.2_SSD (NGFF) Module Installation Guide

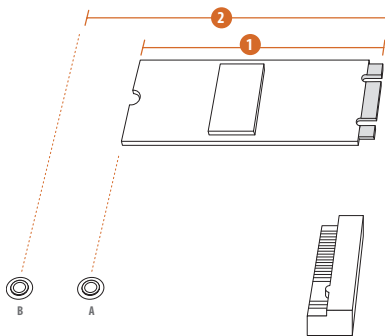
The M.2, also known as the Next Generation Form Factor (NGFF), is a small size and versatile card edge connector that aims to replace mPCIe and mSATA. The Hyper M.2 Socket (M2_1) supports M Key type 2260/2280 M.2 PCI Express module up to Gen4x4 (64 Gb/s) (Only supported with 11th Gen Intel® Core™ Processors). The Ultra M.2 Socket (M2_2), supports M Key type 2260/2280 M.2 SATA3 6.0 Gb/s module and M.2 PCI Express module up to Gen3 x4 (32 Gb/s).

Installing the M.2_SSD (NGFF) Module



Step 1

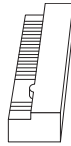
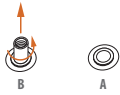
Prepare a M.2_SSD (NGFF) module and the screw.



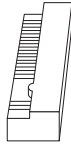
Step 2

Depending on the PCB type and length of your M.2_SSD (NGFF) module, find the corresponding nut location to be used.

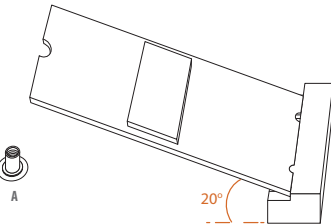
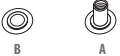
No.	1	2
Nut Location	A	B
PCB Length	6cm	8cm
Module Type	Type2260	Type 2280

**Step 3**

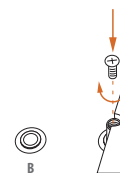
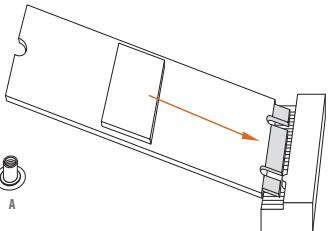
Move the standoff based on the module type and length. The standoff is placed at the nut location B by default. Skip Step 3 and 4 and go straight to Step 5 if you are going to use the default nut. Otherwise, release the standoff by hand.

**Step 4**

Peel off the yellow protective film on the nut to be used. Hand tighten the standoff into the desired nut location on the motherboard.

**Step 5**

Align and gently insert the M.2 (NGFF) SSD module into the M.2 slot. Please be aware that the M.2 (NGFF) SSD module only fits in one orientation.

**Step 6**

Tighten the screw with a screwdriver to secure the module into place. Please do not overtighten the screw as this might damage the module.

M.2_SSD (NGFF) Module Support List (M2_1)

Vendor	Interface	P/N
ADATA	PCIe3 x4	ASX7000NP-128GT-C
ADATA	PCIe3 x4	ASX8000NP-256GM-C
ADATA	PCIe3 x4	ASX7000NP-256GT-C
ADATA	PCIe3 x4	ASX8000NP-512GM-C
ADATA	PCIe3 x4	ASX7000NP-512GT-C
Apacer	PCIe3 x4	AP240GZ280
Corsair	PCIe3 x4	CSSD-F240GBMP500
Intel	PCIe3 x4	SSDPEKKF256G7
Intel	PCIe3 x4	SSDPEKKF512G7
Kingston	PCIe3 x4	SKC1000/480G
Kingston	PCIe2 x4	SH2280S3/480G
OCZ	PCIe3 x4	RVD400 -M2280-512G (NVME)
PATRIOT	PCIe3 x4	PH240GPM280SSDR NVME
Plextor	PCIe3 x4	PX-128M8PeG
Plextor	PCIe3 x4	PX-1TM8PeG
Plextor	PCIe3 x4	PX-256M8PeG
Plextor	PCIe3 x4	PX-512M8PeG
Plextor	PCIe	PX-G256M6e
Plextor	PCIe	PX-G512M6e
Samsung	PCIe3 x4	SM961 MZVPW128HEGM (NVM)
Samsung	PCIe3 x4	PM961 MZVLW128HEGR (NVME)
Samsung	PCIe3 x4	960 EVO (MZ-V6E250) (NVME)
Samsung	PCIe3 x4	960 EVO (MZ-V6E250BW) (NVME)
Samsung	PCIe3 x4	SM951 (NVME)
Samsung	PCIe3 x4	SM951 (MZHPV256HDGL)
Samsung	PCIe3 x4	SM951 (MZHPV512HDGL)
Samsung	PCIe3 x4	SM951 (NVME)
Samsung	PCIe x4	XP941-512G (MZHPU512HCGL)
SanDisk	PCIe	SD6PP4M-128G
SanDisk	PCIe	SD6PP4M-256G
TEAM	PCIe3 x4	TM8FP2240G0C101
TEAM	PCIe3 x4	TM8FP2480GC110
WD	PCIe3 x4	WDS256G1X0C-00ENX0 (NVME)
WD	PCIe3 x4	WDS512G1X0C-00ENX0 (NVME)

For the latest updates of M.2_SSD (NFGG) module support list, please visit our website for details: <http://www.asrock.com>

M.2_SSD (NGFF) Module Support List (M2_2)

Vendor	Interface	P/N
ADATA	SATA3	AXNS330E-32GM-B
ADATA	SATA3	AXNS381E-128GM-B
ADATA	SATA3	AXNS381E-256GM-B
ADATA	SATA3	ASU800NS38-256GT-C
ADATA	SATA3	ASU800NS38-512GT-C
ADATA	PCIe3 x4	ASX7000NP-128GT-C
ADATA	PCIe3 x4	ASX8000NP-256GM-C
ADATA	PCIe3 x4	ASX7000NP-256GT-C
ADATA	PCIe3 x4	ASX8000NP-512GM-C
ADATA	PCIe3 x4	ASX7000NP-512GT-C
Apacer	PCIe3 x4	AP240GZ280
Corsair	PCIe3 x4	CSSD-F240GBMP500
Crucial	SATA3	CT120M500SSD4
Crucial	SATA3	CT240M500SSD4
Intel	SATA3	Intel SSDSCKGW080A401/80G
Intel	PCIe3 x4	SSDPEKKF256G7
Intel	PCIe3 x4	SSDPEKKF512G7
Kingston	SATA3	SM2280S3
Kingston	PCIe3 x4	SKC1000/480G
Kingston	PCIe2 x4	SH2280S3/480G
OCZ	PCIe3 x4	RVD400 -M2280-512G (NVME)
PATRIOT	PCIe3 x4	PH240GPM280SSDR NVME
Plextor	PCIe3 x4	PX-128M8PeG
Plextor	PCIe3 x4	PX-1TM8PeG
Plextor	PCIe3 x4	PX-256M8PeG
Plextor	PCIe3 x4	PX-512M8PeG
Plextor	PCIe	PX-G256M6e
Plextor	PCIe	PX-G512M6e
Samsung	PCIe3 x4	SM961 MZVPPW128HEGM (NVM)
Samsung	PCIe3 x4	PM961 MZVLW128HEGR (NVME)
Samsung	PCIe3 x4	960 EVO (MZ-V6E250) (NVME)
Samsung	PCIe3 x4	960 EVO (MZ-V6E250BW) (NVME)
Samsung	PCIe3 x4	SM951 (NVME)
Samsung	PCIe3 x4	SM951 (MZHPV256HDGL)
Samsung	PCIe3 x4	SM951 (MZHPV512HDGL)
Samsung	PCIe3 x4	SM951 (NVME)
Samsung	PCIe x4	XP941-512G (MZHPU512HCGL)
SanDisk	PCIe	SD6PP4M-128G
SanDisk	PCIe	SD6PP4M-256G
Team	SATA3	TM4PS4128GMC105
Team	SATA3	TM4PS4256GMC105
Team	SATA3	TM8PS4128GMC105
Team	SATA3	TM8PS4256GMC105

TEAM	PCIe3 x4	TM8FP2240G0C101
TEAM	PCIe3 x4	TM8FP2480GC110
Transcend	SATA3	TS256GMTS400
Transcend	SATA3	TS512GMTS600
Transcend	SATA3	TS512GMTS800
V-Color	SATA3	VLM100-120G-2280B-RD
V-Color	SATA3	VLM100-240G-2280RGB
V-Color	SATA3	VSM100-240G-2280
V-Color	SATA3	VLM100-240G-2280B-RD
WD	SATA3	WDS100T1B0B-00AS40
WD	SATA3	WDS240G1G0B-00RC30
WD	PCIe3 x4	WDS256G1X0C-00ENX0 (NVME)
WD	PCIe3 x4	WDS512G1X0C-00ENX0 (NVME)

For the latest updates of M.2_SSD (NFGG) module support list, please visit our website for details: <http://www.asrock.com>

Chapter 3 Software and Utilities Operation

3.1 Installing Drivers

The Support CD that comes with the motherboard contains necessary drivers and useful utilities that enhance the motherboard's features.

Running The Support CD

To begin using the support CD, insert the CD into your CD-ROM drive. The CD automatically displays the Main Menu if "AUTORUN" is enabled in your computer. If the Main Menu does not appear automatically, locate and double click on the file "ASRSETUP.EXE" in the Support CD to display the menu.

Drivers Menu

The drivers compatible to your system will be auto-detected and listed on the support CD driver page. Please click **Install All** or follow the order from top to bottom to install those required drivers. Therefore, the drivers you install can work properly.


Utilities Menu

The Utilities Menu shows the application software that the motherboard supports. Click on a specific item then follow the installation wizard to install it.

3.2 ASRock Motherboard Utility (A-Tuning)

ASRock Motherboard Utility (A-Tuning) is ASRock's multi purpose software suite with a new interface, more new features and improved utilities.

3.2.1 Installing ASRock Motherboard Utility (A-Tuning)

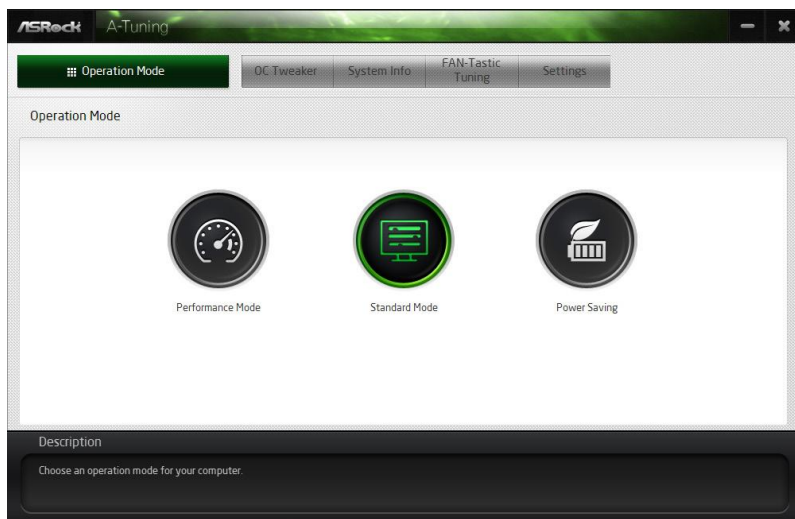
ASRock Motherboard Utility (A-Tuning) can be downloaded from ASRock Live Update & APP Shop. After the installation, you will find the icon "ASRock Motherboard Utility (A-Tuning)" on your desktop. Double-click the "ASRock Motherboard Utility (A-Tuning)"  icon, ASRock Motherboard Utility (A-Tuning) main menu will pop up.

3.2.2 Using ASRock Motherboard Utility (A-Tuning)

There are five sections in ASRock Motherboard Utility (A-Tuning) main menu: Operation Mode, OC Tweaker, System Info, FAN-Tastic Tuning and Settings.

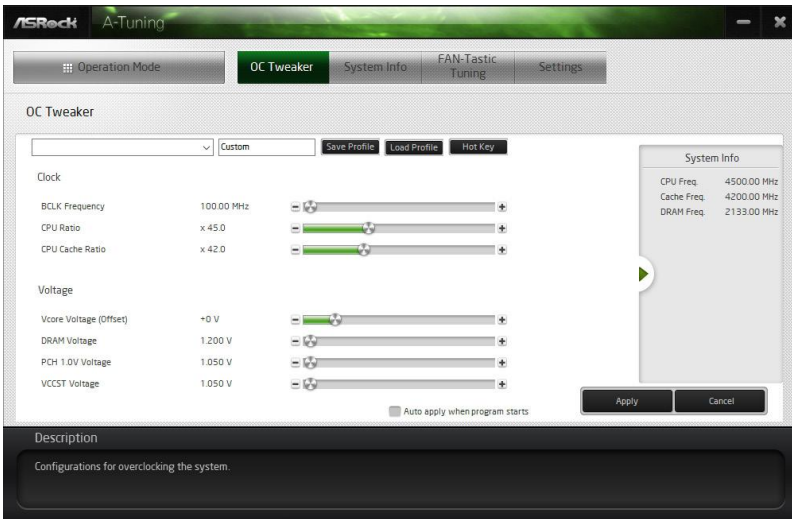
Operation Mode

Choose an operation mode for your computer.



OC Tweaker

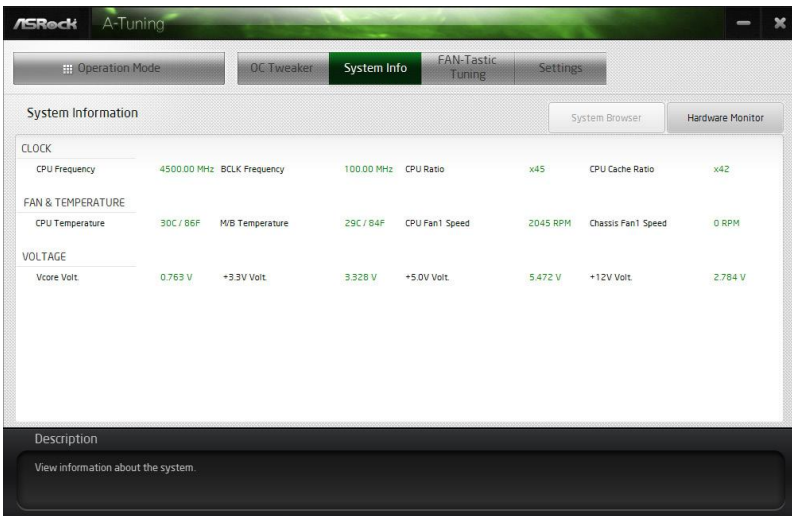
Configurations for overclocking the system.



System Info

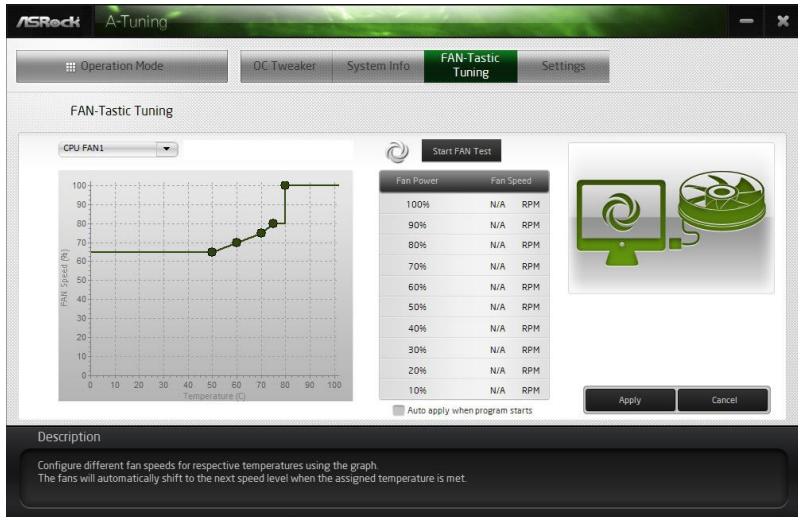
View information about the system.

*The System Browser tab may not appear for certain models.



FAN-Tastic Tuning

Configure up to five different fan speeds using the graph. The fans will automatically shift to the next speed level when the assigned temperature is met.



FAN-Tastic Tuning

CPU FAN1

Start FAN Test

Fan Power	Fan Speed
100%	N/A RPM
90%	N/A RPM
80%	N/A RPM
70%	N/A RPM
60%	N/A RPM
50%	N/A RPM
40%	N/A RPM
30%	N/A RPM
20%	N/A RPM
10%	N/A RPM

Auto apply when program starts

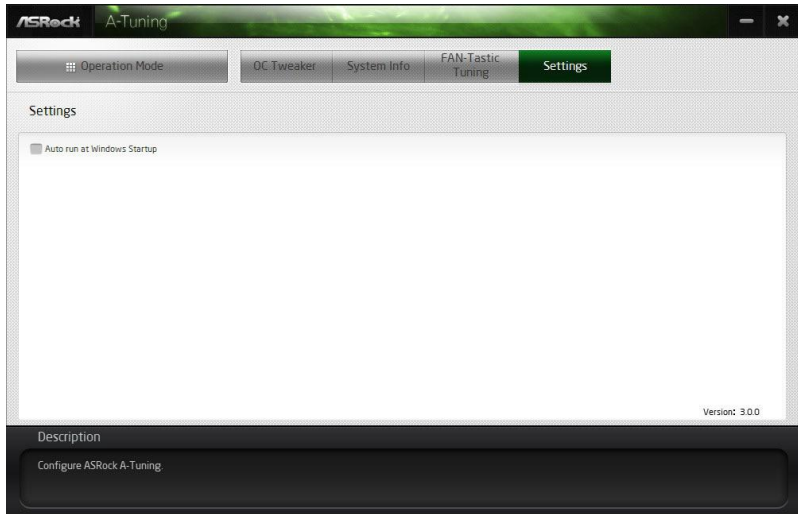
Apply Cancel

Description

Configure different fan speeds for respective temperatures using the graph. The fans will automatically shift to the next speed level when the assigned temperature is met.

Settings

Configure ASRock ASRock Motherboard Utility (A-Tuning). Click to select "Auto run at Windows Startup" if you want ASRock Motherboard Utility (A-Tuning) to be launched when you start up the Windows operating system.



Settings

Auto run at Windows Startup


Version: 3.0.0

Description

Configure ASRock A-Tuning.

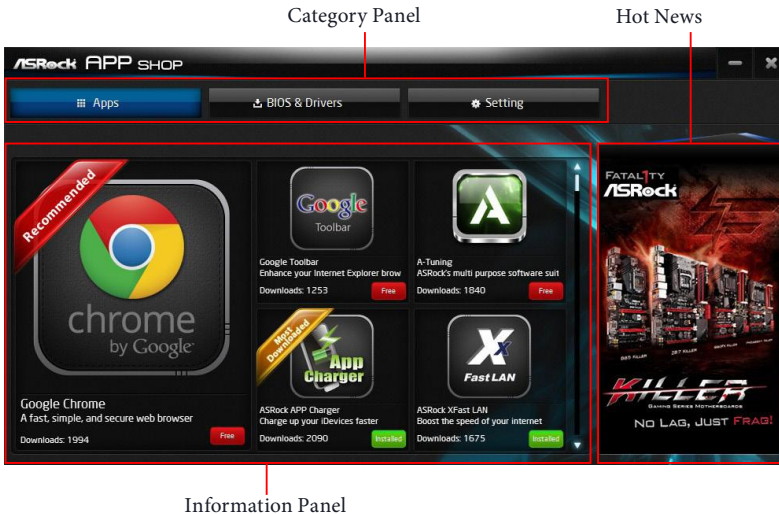
3.3 ASRock Live Update & APP Shop

The ASRock Live Update & APP Shop is an online store for purchasing and downloading software applications for your ASRock computer. You can quickly and easily install various apps and support utilities. With ASRock Live Update & APP Shop, you can optimize your system and keep your motherboard up to date simply with a few clicks.

Double-click  on your desktop to access ASRock Live Update & APP Shop utility.

**You need to be connected to the Internet to download apps from the ASRock Live Update & APP Shop.*

3.3.1 UI Overview



Category Panel: The category panel contains several category tabs or buttons that when selected the information panel below displays the relative information.

Information Panel: The information panel in the center displays data about the currently selected category and allows users to perform job-related tasks.

Hot News: The hot news section displays the various latest news. Click on the image to visit the website of the selected news and know more.

3.3.2 Apps

When the "Apps" tab is selected, you will see all the available apps on screen for you to download.

Installing an App

Step 1

Find the app you want to install.



The most recommended app appears on the left side of the screen. The other various apps are shown on the right. Please scroll up and down to see more apps listed.

You can check the price of the app and whether you have already installed it or not.


Free - The red icon displays the price or "Free" if the app is free of charge.

Installed - The green "Installed" icon means the app is installed on your computer.

Step 2

Click on the app icon to see more details about the selected app.

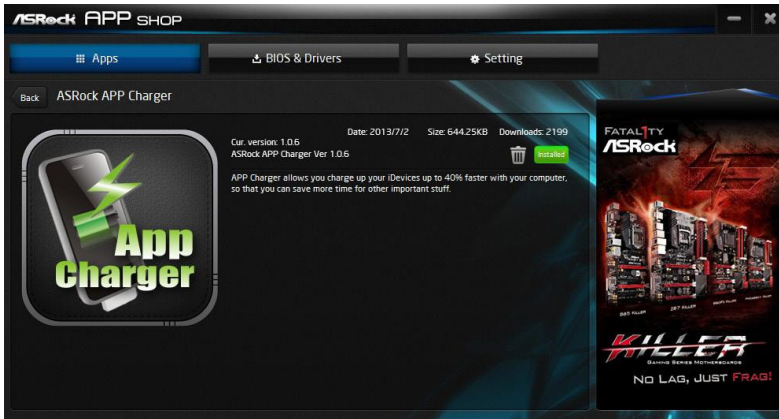
Step 3


If you want to install the app, click on the red icon  to start downloading.




Step 4

When installation completes, you can find the green "Installed" icon appears on the upper right corner.



To uninstall it, simply click on the trash can icon .
*The trash icon may not appear for certain apps.

Upgrading an App

You can only upgrade the apps you have already installed. When there is an available new version for your app, you will find the mark of "New Version"  appears below the installed app icon.



Step 1

Click on the app icon to see more details.

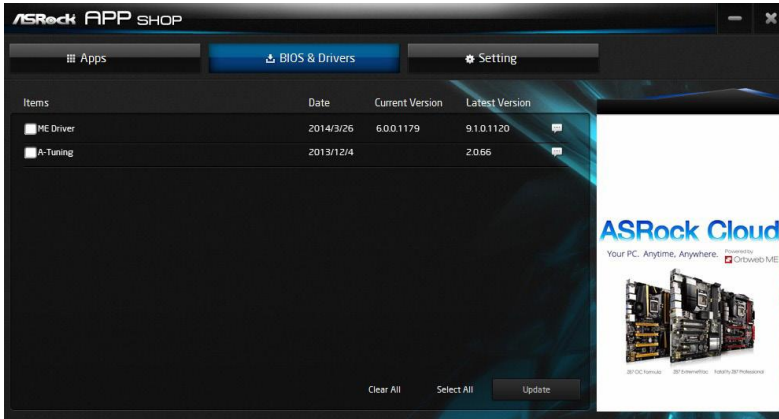
Step 2

Click on the yellow icon  to start upgrading.


3.3.3 BIOS & Drivers

Installing BIOS or Drivers

When the "BIOS & Drivers" tab is selected, you will see a list of recommended or critical updates for the BIOS or drivers. Please update them all soon.



Step 1

Please check the item information before update. Click on  to see more details.

Step 2

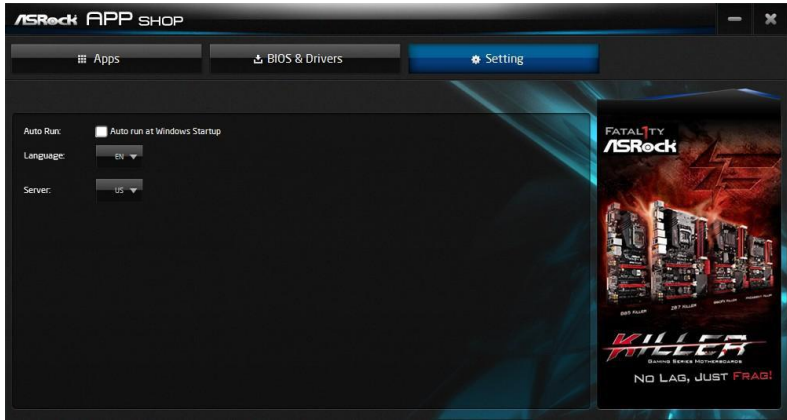
Click to select one or more items you want to update.

Step 3

Click Update to start the update process.

3.3.4 Setting

In the "Setting" page, you can change the language, select the server location, and determine if you want to automatically run the ASRock Live Update & APP Shop on Windows startup.



Chapter 4 UEFI SETUP UTILITY

4.1 Introduction

This section explains how to use the UEFI SETUP UTILITY to configure your system. You may run the UEFI SETUP UTILITY by pressing <F2> or right after you power on the computer, otherwise, the Power-On-Self-Test (POST) will continue with its test routines. If you wish to enter the UEFI SETUP UTILITY after POST, restart the system by pressing <Ctl> + <Alt> + <Delete>, or by pressing the reset button on the system chassis. You may also restart by turning the system off and then back on.

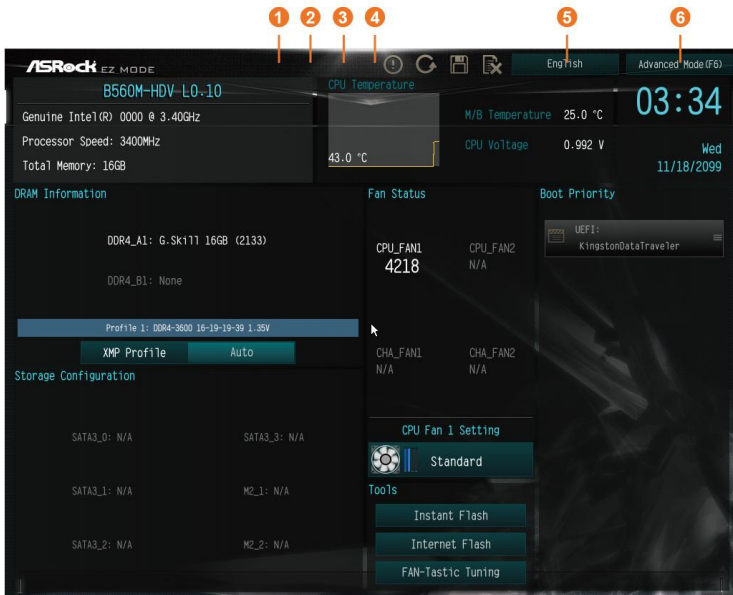


Because the UEFI software is constantly being updated, the following UEFI setup screens and descriptions are for reference purpose only, and they may not exactly match what you see on your screen.

4.2 EZ Mode

The EZ Mode screen appears when you enter the BIOS setup program by default. EZ mode is a dashboard which contains multiple readings of the system's current status. You can check the most crucial information of your system, such as CPU speed, DRAM frequency, SATA information, fan speed, etc.

Press <F6> or click the "Advanced Mode" button at the upper right corner of the screen to switch to "Advanced Mode" for more options.



No.	Function
1	Help
2	Load UEFI Defaults
3	Save Changes and Exit
4	Discard Changes
5	Change Language
6	Switch to Advanced Mode

4.3 Advanced Mode

The Advanced Mode provides more options to configure the BIOS settings. Refer to the following sections for the detailed configurations.

To access the EZ Mode, press <F6> or click the "EZ Mode" button at the upper right corner of the screen.

4.3.1 UEFI Menu Bar

The top of the screen has a menu bar with the following selections:

Main	For setting system time/date information
OC Tweaker	For overclocking configurations
Advanced	For advanced system configurations
Tool	Useful tools
H/W Monitor	Displays current hardware status
Security	For security settings
Boot	For configuring boot settings and boot priority
Exit	Exit the current screen or the UEFI Setup Utility

4.3.2 Navigation Keys

Use <←> key or <→> key to choose among the selections on the menu bar, and use <↑> key or <↓> key to move the cursor up or down to select items, then press <Enter> to get into the sub screen. You can also use the mouse to click your required item.

Please check the following table for the descriptions of each navigation key.

Navigation Key(s)	Description
+ / -	To change option for the selected items
<Tab>	Switch to next function
<PGUP>	Go to the previous page
<PGDN>	Go to the next page
<HOME>	Go to the top of the screen
<END>	Go to the bottom of the screen
<F1>	To display the General Help Screen
<F5>	Add / Remove Favorite
<F7>	Discard changes and exit the SETUP UTILITY
<F9>	Load optimal default values for all the settings
<F10>	Save changes and exit the SETUP UTILITY
<F12>	Print screen
<ESC>	Jump to the Exit Screen or exit the current screen

4.4 Main Screen

When you enter the UEFI SETUP UTILITY, the Main screen will appear and display the system overview.



The availability and location of BIOS settings can be different for different models and BIOS versions.



My Favorite

Display your collection of BIOS items. Press F5 to add/remove your favorite items.

4.5 OC Tweaker Screen

In the OC Tweaker screen, you can set up overclocking features.



Because the UEFI software is constantly being updated, the following UEFI setup screens and descriptions are for reference purpose only, and they may not exactly match what you see on your screen.

CPU Configuration

CPU Ratio

The CPU speed is determined by the CPU Ratio multiplied with the BCLK. Increasing the CPU Ratio will increase the internal CPU clock speed without affecting the clock speed of other components.

AVX2 Ratio Offset

AVX2 Ratio Offset specifies a negative offset from the CPU Ratio for AVX workloads. AVX is a more stressful workload that lower the AVX ratio to ensure maximum possible ratio for SSE workloads.

AVX-512 Ratio Offset

AVX-512 Ratio Offset specifies a negative offset from the CPU Ratio for AVX-512 workloads. AVX-512 is a more stressful workload that lower the AVX ratio to ensure maximum possible ratio for SSE workloads.

CPU Cache Ratio

The CPU Internal Bus Speed Ratio. The maximum should be the same as the CPU Ratio.

GT Frequency

Configure the integrated GPU Frequency.

BCLK Spread Spectrum Mode

Enable Spread Spectrum to reduce electromagnetic interference for passing EMI tests. Disable to achieve higher clock speeds when overclocking.

BCLK Aware Adaptive Voltage

BCLK Aware Adaptive Voltage enable/disable. When enabled, pcode will be aware of the BCLK frequency when calculating the CPU V/F curves. This is ideal for BCLK OC to avoid high voltage overrides.

Boot Performance Mode

Select the performance state that the BIOS will set before OS handoff.

Ring to Core Ratio Offset

Disable Ring to Core Ratio Offset so the ring and core can run at the same frequency.

PVD Ratio Threshold

Select PVD Ratio Threshold Value from Range 1 to 40.

Intel SpeedStep Technology

Intel SpeedStep technology allows processors to switch between multiple frequencies and voltage points for better power saving and heat dissipation.

Intel Turbo Boost Technology

Intel Turbo Boost Technology enables the processor to run above its base operating frequency when the operating system requests the highest performance state.

Intel Speed Shift Technology

Enable/Disable Intel Speed Shift Technology support. Enabling will expose the CPPC v2 interface to allow for hardware controlled P-states.

Intel Turbo Boost Max Technology 3.0

Intel Turbo Boost Technology enables the processor to run above its base operating frequency when the operating system requests the highest performance state.

Intel Thermal Velocity Boost Voltage Optimizations

This service controls thermal based voltage optimizations for processors that implement the Intel Thermal Velocity Boost (TVB) feature.

Dual Tau Boost

Enable Dual Tau Boost feature. This is only applicable for CMLS 35W/65W/125W skus. This item is only supported with processors with Config TDP support.

Long Duration Power Limit

Configure Package Power Limit 1 in watts. When the limit is exceeded, the CPU ratio will be lowered after a period of time. A lower limit can protect the CPU and save power, while a higher limit may improve performance.

Long Duration Maintained

Configure the period of time until the CPU ratio is lowered when the Long Duration Power Limit is exceeded.

Short Duration Power Limit

Configure Package Power Limit 2 in watts. When the limit is exceeded, the CPU ratio will be lowered immediately. A lower limit can protect the CPU and save power, while a higher limit may improve performance.

CPU Core Current Limit

Configure the current limit of the CPU core. A lower limit can protect the CPU and save power, while a higher limit may improve performance.

System Agent Current Limit

Configure the current limit of the system agent. A lower limit can protect the CPU and save power, while a higher limit may improve performance.

GT Current Limit

Configure the current limit of the GT slice. A lower limit can protect the CPU and save power, while a higher limit may improve performance.

DRAM Configuration

Memory Information

Allows users to browse the serial presence detect (SPD) and Intel extreme memory profile (XMP) for DDR4 modules.

DRAM Timing Configuration

Load XMP Setting

Load XMP settings to overclock the memory and perform beyond standard specifications.

DRAM Reference Clock

Select Auto for optimized settings.

DRAM Frequency

If [Auto] is selected, the motherboard will detect the memory module(s) inserted and assign the appropriate frequency automatically.

DRAM Gear Mode

Gear2 mode doubled the ratio in memory controller, and it is good for high frequency.

System Agent Geyserville

Configure System Agent Geyserville (SA GV) settings.

Primary Timing

CAS# Latency (tCL)

The time between sending a column address to the memory and the beginning of the data in response.

RAS# to CAS# Delay and Row Precharge (tRCDtRP)

RAS# to CAS# Delay : The number of clock cycles required between the opening of a row of memory and accessing columns within it.

Row Precharge: The number of clock cycles required between the issuing of the precharge command and opening the next row.

RAS# Active Time (tRAS)

The number of clock cycles required between a bank active command and issuing the precharge command.

Command Rate (CR)

The delay between when a memory chip is selected and when the first active command can be issued.

Secondary Timing

Write Recovery Time (tWR)

The amount of delay that must elapse after the completion of a valid write operation, before an active bank can be precharged.

Refresh Cycle Time (tRFC)

The number of clocks from a Refresh command until the first Activate command to the same rank.

RAS to RAS Delay (tRRD_L)

The number of clocks between two rows activated in different banks of the same rank.

RAS to RAS Delay (tRRD_S)

The number of clocks between two rows activated in different banks of the same rank.

Write to Read Delay (tWTR_L)

The number of clocks between the last valid write operation and the next read command to the same internal bank.

Write to Read Delay (tWTR_S)

The number of clocks between the last valid write operation and the next read command to the same internal bank.

Read to Precharge (tRTP)

The number of clocks that are inserted between a read command to a row precharge command to the same rank.

Four Activate Window (tFAW)

The time window in which four activates are allowed the same rank.

CAS Write Latency (tCWL)

Configure CAS Write Latency.

Third Timing

tREFI

Configure refresh cycles at an average periodic interval.

tCKE

Configure the period of time the DDR4 initiates a minimum of one refresh command internally once it enters Self-Refresh mode.

Turn Around Timing

tRDRD_sg

Configure between module read to read delay.

tRDRD_dg

Configure between module read to read delay.

tRDRD_dr

Configure between module read to read delay.

tRDRD_dd

Configure between module read to read delay.

tRDWR_sg

Configure between module read to write delay.

tRDWR_dg

Configure between module read to write delay.

tRDWR_dr

Configure between module read to write delay.

tRDWR_dd

Configure between module read to write delay.

tWRRD_sg

Configure between module write to read delay.

tWRRD_dg

Configure between module write to read delay.

tWRRD_dr

Configure between module write to read delay.

tWRRD_dd

Configure between module write to read delay.

tWRWR_sg

Configure between module write to write delay.

tWRWR_dg

Configure between module write to write delay.

tWRWR_dr

Configure between module write to write delay.

tWRWR_dd

Configure between module write to write delay.

Round Trip Timing

Round Trip Timing Optimization

Auto is enabled in general case.

Initial RTL (A1 Rank1)

Configure round trip latency initial value.

Initial RTL (A1 Rank2)

Configure round trip latency initial value.

Initial RTL (B1 Rank1)

Configure round trip latency initial value.

Initial RTL (B1 Rank2)

Configure round trip latency initial value.

RTL (A1 Rank1)

Configure round trip latency.

RTL (A1 Rank2)

Configure round trip latency.

RTL (B1 Rank1)

Configure round trip latency.

RTL (B1 Rank2)

Configure round trip latency.

IOL Init Value

Configure IO latency init value for IO latency training.

IOL (A1 Rank1)

Configure IO latency.

IOL (A1 Rank2)

Configure IO latency.

IOL (B1 Rank1)

Configure IO latency.

IOL (B1 Rank2)

Configure IO latency.

IOL Offset (CH A)

Configure IO latency offset for channel A.

IOL Offset (CH B)

Configure IO latency offset for channel B.

ODT Setting

Dimm ODT Training

ODT values will be optimized by Dimm On-Die Termination Training.

ODT WR (A1)

Configure the memory on die termination resistors' WR for channel A1.

ODT WR (B1)

Configure the memory on die termination resistors' WR for channel B1.

ODT NOM (A1)

Use this to change ODT (CH A1) Auto/Manual settings. The default is [Auto].

ODT NOM (B1)

Use this to change ODT (CH B1) Auto/Manual settings. The default is [Auto].

ODT PARK (A1)

Configure the memory on die termination resistors' PARK for channel A1.

ODT PARK (B1)

Configure the memory on die termination resistors' PARK for channel B1.

COMP Setting

Dll Bandwidth 0

Configure Dll Bandwidth 0 (1067 MHz) to maximize the performance of intergrated memory controller.

Dll Bandwidth 1

Configure Dll Bandwidth 1 (1333 MHz) to maximize the performance of intergrated memory controller.

Dll Bandwidth 2

Configure Dll Bandwidth 2 (1600 MHz) to maximize the performance of intergrated memory controller.

Dll Bandwidth 3

Configure Dll Bandwidth 3 (1867 MHz) to maximize the performance of intergrated memory controller.

Advanced Setting

ASRock Timing Optimization

Configure the fast path through the MRC.

ASRock Second Timing Optimization

Configure the second fast path through the MRC.

Memory Training Mode

Configure the Training Memory Mode.

Realtime Memory Timing

Configure the realtime memory timings.

[Enabled] The system will allow performing realtime memory timing changes after MRC_DONE.

Reset for MRC Failed

Reset system after MRC training is failed.

Train on Warm Boot

When enabled, memory training will be executed when warm boot.

MRC Fast Boot

Enable Memory Fast Boot to skip DRAM memory training for booting faster.

Voltage Configuration

Voltage Mode

[OC]: Larger range voltage for overclocking.

[STABLE]: Smaller range voltage for stable system.

CPU Core/Cache Voltage

Input voltage for the processor by the external voltage regulator.

CPU Core/Cache Load-Line Calibration

CPU Core/Cache Load-Line Calibration helps prevent CPU Core/Cache voltage droop when the system is under heavy loading.

CPU GT Voltage

Configure the voltage for the integrated GPU.

CPU GT Load-Line Calibration

GT Load-Line Calibration helps prevent integrated GPU voltage droop when the system is under heavy load.

VCCSA Voltage

Configure the voltage for the VCCSA.

DRAM Voltage

Use this to configure DRAM Voltage. The default value is [Auto].

VCCIO Voltage

Configure the voltage for the VCCIO.

DRAM Activating Power Supply

Configure the voltage for the DRAM Activating Power Supply.

VCCIN AUX Voltage

Configure the voltage for the VCCIN AUX.

CPU Standby Voltage

Configure the voltage for the CPU Standby.

AVX Configuration

AVX2 Voltage Guardband Scale Factor

AVX2 Voltage Guardband Scale Factor controls the voltage guardband applied to AVX2 workloads. A value > 1.00 will increase the voltage guardband, and < 1.00 will decrease the voltage guardband.

AVX-512 Voltage Guardband Scale Factor

AVX-512 Voltage Guardband Scale Factor controls the voltage guardband applied to AVX-512 workloads. A value > 1.00 will increase the voltage guardband, and < 1.00 will decrease the voltage guardband.

Save User Default

Type a profile name and press enter to save your settings as user default.

Load User Default

Load previously saved user defaults.

Save User UEFI Setup Profile to Disk

It helps you to save current UEFI settings as an user profile to disk.

Load User UEFI Setup Profile from Disk

You can load previous saved profile from the disk.

4.6 Advanced Screen

In this section, you may set the configurations for the following items: CPU Configuration, Chipset Configuration, Storage Configuration, Super IO Configuration, ACPI Configuration, USB Configuration and Trusted Computing.



Setting wrong values in this section may cause the system to malfunction.

UEFI Configuration

UEFI Setup Style

Select the default mode when entering the UEFI setup utility.

Active Page on Entry

Select the default page when entering the UEFI setup utility.

Full HD UEFI

When [Auto] is selected, the resolution will be set to 1920 x 1080 if the monitor supports Full HD resolution. If the monitor does not support Full HD resolution, then the resolution will be set to 1024 x 768. When [Disable] is selected, the resolution will be set to 1024 x 768 directly.

4.6.1 CPU Configuration



Intel Hyper Threading Technology

Intel Hyper Threading Technology allows multiple threads to run on each core, so that the overall performance on threaded software is improved.

Active Processor Cores

Select the number of cores to enable in each processor package.

CPU C States Support

Enable CPU C States Support for power saving. It is recommended to keep C6 and C7 all enabled for better power saving.

Enhanced Halt State (C1E)

Enable Enhanced Halt State (C1E) for lower power consumption.

CPU C6 State Support

Enable C6 deep sleep state for lower power consumption.

CPU C7 State Support

Enable C7 deep sleep state for lower power consumption.

Package C State Support

Enable CPU, PCIe, Memory, Graphics C State Support for power saving.

CFG Lock

This item allows you to disable or enable the CFG Lock.

C6DRAM

Enable/Disable moving of DRAM contents to PRM memory when CPU is in C6 state.

CPU Thermal Throttling

Enable CPU internal thermal control mechanisms to keep the CPU from overheating.

Intel AVX/AVX2

Enable/Disable the Intel AVX and AVX2 Instructions. This is applicable for Big Core only.

Intel AVX-512

Enable/Disable the Intel AVX-512 (a.k.a. AVX3) Instructions. This is applicable for Big Core only.

Intel Virtualization Technology

Intel Virtualization Technology allows a platform to run multiple operating systems and applications in independent partitions, so that one computer system can function as multiple virtual systems.

Hardware Prefetcher

Automatically prefetch data and code for the processor. Enable for better performance.

Adjacent Cache Line Prefetch

Automatically prefetch the subsequent cache line while retrieving the currently requested cache line. Enable for better performance.

4.6.2 Chipset Configuration



Primary Graphics Adaptor

Select a primary VGA.

Above 4G Decoding

Enable or disable 64bit capable Devices to be decoded in Above 4G Address Space (only if the system supports 64 bit PCI decoding).

VT-d

Intel® Virtualization Technology for Directed I/O helps your virtual machine monitor better utilize hardware by improving application compatibility and reliability, and providing additional levels of manageability, security, isolation, and I/O performance.

SR-IOV Support

If system has SR-IOV capable PCIe Devices, this option Enables or Disables Single Root IO Virtualization Support.

DMI Link Speed

Configure DMI Slot Link Speed. Auto mode is optimizing for overclocking.

PCIE1 Link Speed

Select the link speed for PCIE1.

PCIe2 Link Speed

Select the link speed for PCIe2.

PCIe3 Link Speed

Select the link speed for PCIe3.

PCI Express Native Control

Select Enable for enhanced PCI Express power saving in OS.

PCIe ASPM Support

This option enables/disables the ASPM support for all CPU downstream devices.

PCH PCIe ASPM Support

This option enables/disables the ASPM support for all PCH PCIe devices.

DMI ASPM Support

This option enables/disables the control of ASPM on CPU side of the DMI Link.

PCH DMI ASPM Support

This option enables/disables the ASPM support for all PCH DMI devices.

Share Memory

Configure the size of memory that is allocated to the integrated graphics processor when the system boots up.

IGPU Multi-Monitor

Select disable to disable the integrated graphics when an external graphics card is installed. Select enable to keep the integrated graphics enabled at all times.

Inte(R) Ethernet Connection I219-V

Enable or disable the onboard network interface controller (Intel® I219V).

Onboard HD Audio

Enable/disable onboard HD audio. Set to Auto to enable onboard HD audio and automatically disable it when a sound card is installed.

Front Panel

Enable/disable front panel HD audio.

Onboard HDMI HD Audio

Enable audio for the onboard digital outputs.

Deep Sleep

Configure deep sleep mode for power saving when the computer is shut down.

Restore on AC/Power Loss

Select the power state after a power failure. If [Power Off] is selected, the power will remain off when the power recovers. If [Power On] is selected, the system will start to boot up when the power recovers.

4.6.3 Storage Configuration



SATA Controller(s)

Enable/disable the SATA controllers.

SATA Mode Selection

AHCI: Supports new features that improve performance.

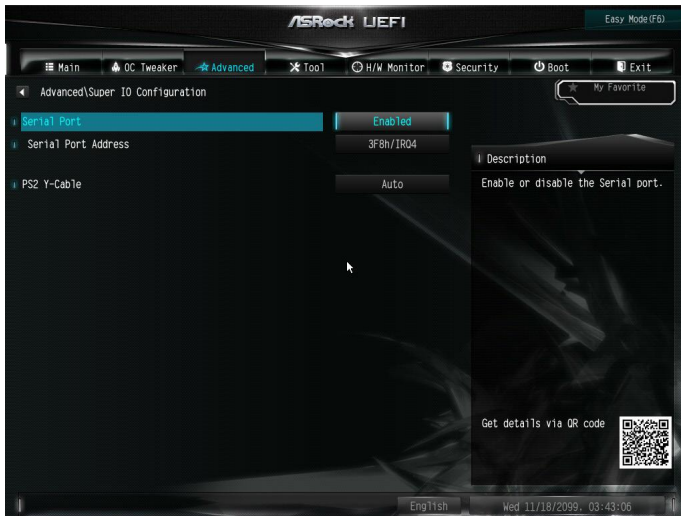
SATA Aggressive Link Power Management

SATA Aggressive Link Power Management allows SATA devices to enter a low power state during periods of inactivity to save power. It is only supported by AHCI mode.

Hard Disk S.M.A.R.T.

S.M.A.R.T stands for Self-Monitoring, Analysis, and Reporting Technology. It is a monitoring system for computer hard disk drives to detect and report on various indicators of reliability.

4.6.4 Super IO Configuration



Serial Port

Enable or disable the Serial port.

Serial Port Address

Select the address of the Serial port.

PS2 Y-Cable

Enable the PS2 Y-Cable or set this option to Auto.

4.6.5 ACPI Configuration



Suspend to RAM

Select disable for ACPI suspend type S1. It is recommended to select auto for ACPI S3 power saving.

PS/2 Keyboard S4/S5 Wakeup Support

Allow the system to be waked up by a PS/2 Keyboard in S4/S5.

PCIE Devices Power On

Allow the system to be waked up by a PCIE device and enable wake on LAN.

I219 LAN Power On

Allow the system to be waked up by the Onboard Intel LAN.

RTC Alarm Power On

Allow the system to be waked up by the real time clock alarm. Set it to By OS to let it be handled by your operating system.

USB Keyboard/Remote Power On

Allow the system to be waked up by an USB keyboard or remote controller.

USB Mouse Power On

Allow the system to be waked up by an USB mouse.

4.6.6 USB Configuration



Legacy USB Support

Enable or disable Legacy OS Support for USB 2.0 devices. If you encounter USB compatibility issues it is recommended to disable legacy USB support. Select UEFI Setup Only to support USB devices under the UEFI setup and Windows/Linux operating systems only.

XHCI Hand-off

This is a workaround for OSes without XHCI hand-off support. The XHCI ownership change should be claimed by XHCI driver.

4.6.7 Trusted Computing



Security Device Support

Enable or disable BIOS support for security device.

4.7 Tools



UEFI Tech Service

Contact ASRock Tech Service if you are having trouble with your PC. Please setup network configuration before using UEFI Tech Service.

SSD Secure Erase Tool

All the SSD's listed that supports Secure Erase function.

NVME Sanitization Tool

After you Sanitize SSD, all user data will be permanently destroyed on the SSD and cannot be recovered.

Instant Flash

Save UEFI files in your USB storage device and run Instant Flash to update your UEFI.

Internet Flash - DHCP (Auto IP), Auto

ASRock Internet Flash downloads and updates the latest UEFI firmware version from our servers for you. Please setup network configuration before using Internet Flash.

*For BIOS backup and recovery purpose, it is recommended to plug in your USB pen drive before using this function.

Network Configuration

Use this to configure internet connection settings for Internet Flash.



Internet Setting

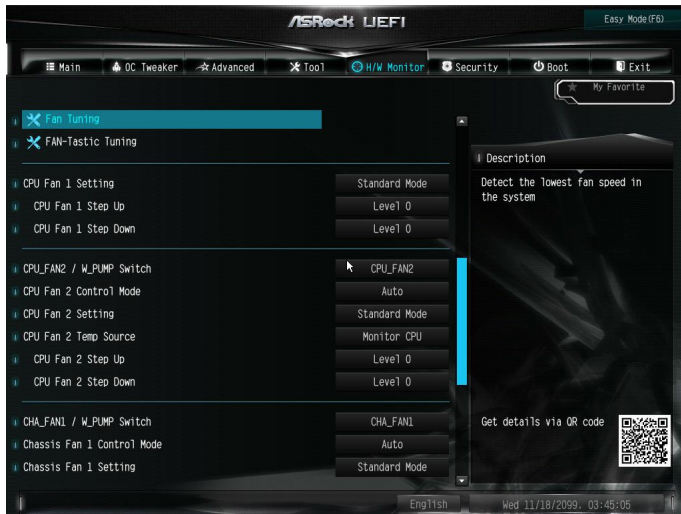
Enable or disable sound effects in the setup utility.

UEFI Download Server

Select a server to download the UEFI firmware.

4.8 Hardware Health Event Monitoring Screen

This section allows you to monitor the status of the hardware on your system, including the parameters of the CPU temperature, motherboard temperature, fan speed and voltage.



Fan Tuning

Measure Fan Min Duty Cycle.

Fan-Tastic Tuning

Select a fan mode for CPU Fan, or choose Customize to set 5 CPU temperatures and assign a respective fan speed for each temperature.

CPU Fan 1 Setting

Select a fan mode for CPU Fan 1, or choose Customize to set 5 CPU temperatures and assign a respective fan speed for each temperature.

CPU Fan 1 Step Up

Set the value of CPU Fan 1 Step Up.

CPU Fan 1 Step Down

Set the value of CPU Fan 1 Step Down.

CPU_FAN2 / W_PUMP Switch

Switch CPU_FAN2 / W_PUMP header function.

CPU Fan 2 Control Mode

Select DC/PWM mode for CPU Fan 2.

CPU Fan 2 Setting

Select a fan mode for CPU Fan 2, or choose Customize to set 5 CPU temperatures and assign a respective fan speed for each temperature.

CPU Fan 2 Temp Source

Select a fan temperature source for CPU Fan 2.

CPU Fan 2 Step Up

Set the value of CPU Fan 2 Step Up.

CPU Fan 2 Step Down

Set the value of CPU Fan 2 Step Down.

CHA_FAN1 / W_PUMP Switch

Select Chassis Fan 1 or Water Pump mode.

Chassis Fan 1 Control Mode

Select PWM mode or DC mode for Chassis Fan 1.

Chassis Fan 1 Setting

Select a fan mode for Chassis Fan 1, or choose Customize to set 5 CPU temperatures and assign a respective fan speed for each temperature.

Chassis Fan 1 Temp Source

Select a fan temperature source for Chassis Fan 1.

Chassis Fan 1 Step Up

Set the value of Chassis Fan 1 Step Up.

Chassis Fan 1 Step Down

Set the value of Chassis Fan 1 Step Down.

CHA_FAN2 / W_PUMP Switch

Select Chassis Fan 2 or Water Pump mode.

Chassis Fan 2 Control Mode

Select PWM mode or DC mode for Chassis Fan 2.

Chassis Fan 2 Setting

Select a fan mode for Chassis Fan 2, or choose Customize to set 5 CPU temperatures and assign a respective fan speed for each temperature.

Chassis Fan 2 Temp Source

Select a fan temperature source for Chassis Fan 2.

Chassis Fan 2 Step Up

Set the value of Chassis Fan 2 Step Up.

Chassis Fan 2 Step Down

Set the value of Chassis Fan 2 Step Down.

Case Open Feature

Enable or disable the feature of Case Open.

4.9 Security Screen

In this section you may set or change the supervisor/user password for the system. You may also clear the user password.



Supervisor Password

Set or change the password for the administrator account. Only the administrator has authority to change the settings in the UEFI Setup Utility. Leave it blank and press enter to remove the password.

User Password

Set or change the password for the user account. Users are unable to change the settings in the UEFI Setup Utility. Leave it blank and press enter to remove the password.

Secure Boot

Use this item to enable or disable support for Secure Boot.

Intel(R) Platform Trust Technology

Enable/disable Intel PTT in ME. Disable this option to use discrete TPM Module.

4.10 Boot Screen

This section displays the available devices on your system for you to configure the boot settings and the boot priority.



Fast Boot

Fast Boot minimizes your computer's boot time. In fast mode you may not boot from an USB storage device. The VBIOS must support UEFI GOP if you are using an external graphics card. Please notice that Ultra Fast mode will boot so fast that the only way to enter this UEFI Setup Utility is to Clear CMOS or run the Restart to UEFI utility in Windows.

Boot From Onboard LAN

Allow the system to be waked up by the onboard LAN.

Setup Prompt Timeout

Configure the number of seconds to wait for the setup hot key.

Bootup Num-Lock

Select whether Num Lock should be turned on or off when the system boots up.

Boot Beep

Select whether the Boot Beep should be turned on or off when the system boots up. Please note that a buzzer is needed.

Full Screen Logo

Enable to display the boot logo or disable to show normal POST messages.

AddOn ROM Display

Enable AddOn ROM Display to see the AddOn ROM messages or configure the AddOn ROM if you've enabled Full Screen Logo. Disable for faster boot speed.

Boot Failure Guard Message

If the computer fails to boot for a number of times the system automatically restores the default settings.

CSM (Compatibility Support Module)



CSM

Enable to launch the Compatibility Support Module. Please do not disable unless you're running a WHCK test.

Launch PXE OpROM Policy

Select UEFI only to run those that support UEFI option ROM only. Select Legacy only to run those that support legacy option ROM only. Select Do not launch to not execute both legacy and UEFI option ROM.

Launch Storage OpROM Policy

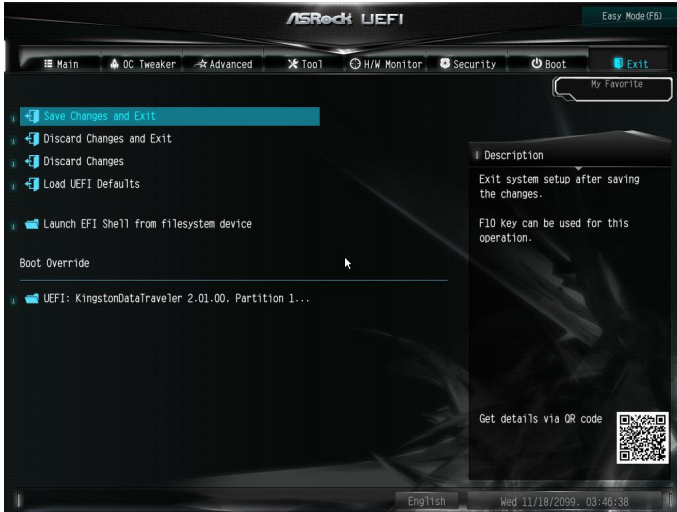
Select UEFI only to run those that support UEFI option ROM only. Select Legacy

only to run those that support legacy option ROM only. Select Do not launch to not execute both legacy and UEFI option ROM.

Other PCI Device ROM Priority

For PCI devices other than Network, Mass storage or Video defines which OpROM to launch.

4.11 Exit Screen



Save Changes and Exit

When you select this option the following message, “Save configuration changes and exit setup?” will pop out. Select [OK] to save changes and exit the UEFI SETUP UTILITY.

Discard Changes and Exit

When you select this option the following message, “Discard changes and exit setup?” will pop out. Select [OK] to exit the UEFI SETUP UTILITY without saving any changes.

Discard Changes

When you select this option the following message, “Discard changes?” will pop out. Select [OK] to discard all changes.

Load UEFI Defaults

Load UEFI default values for all options. The F9 key can be used for this operation.

Launch EFI Shell from filesystem device

Copy shellx64.efi to the root directory to launch EFI Shell.

Contact Information

If you need to contact ASRock or want to know more about ASRock, you're welcome to visit ASRock's website at <http://www.asrock.com>; or you may contact your dealer for further information. For technical questions, please submit a support request form at <https://event.asrock.com/tsd.asp>

ASRock Incorporation

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DECLARATION OF CONFORMITY

Per FCC Part 2 Section 2.1077(a)



Responsible Party Name: ASRock Incorporation

Address: 13848 Magnolia Ave, Chino, CA91710

Phone/Fax No: +1-909-590-8308/+1-909-590-1026

hereby declares that the product

Product Name : Motherboard

Model Number : B560M-HDV

Conforms to the following specifications:

FCC Part 15, Subpart B, Unintentional Radiators

Supplementary Information:

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Representative Person's Name: James

Signature:

A handwritten signature in black ink, appearing to read 'James', written over a horizontal line.

Date : May 12, 2017

EU Declaration of Conformity

ASRock®

For the following equipment:

Motherboard

(Product Name)

B560M-HDV / ASRock

(Model Designation / Trade Name)

ASRock Incorporation

(Manufacturer Name)

2F, No.37, Sec. 2, Jhongyang S. Rd., Beitou District, Taipei City 112, Taiwan (R.O.C.)

(Manufacturer Address)

EMC —Directive 2014/30/EU (from April 20th, 2016)

EN 55022:2010/AC:2011 Class B

EN 55024:2010/A1:2015

EN 55032:2012+AC:2013 Class B

EN 61000-3-3:2013

EN 61000-3-2:2014

LVD —Directive 2014/35/EU (from April 20th, 2016)

EN 60950-1 : 2011+ A2: 2013

EN 60950-1 : 2006/A12: 2011

RoHS — Directive 2011/65/EU

CE marking

(EU conformity marking)



ASRock EUROPE B.V.

(Company Name)

Bijsterhuizen 1111 6546 AR Nijmegen The Netherlands

(Company Address)

Person responsible for making this declaration:

(Name, Surname)

A.V.P

(Position / Title)

January 29, 2021

(Date)

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